EVERLIGHT ELECTRONICS CO.,LTD

Technical Data Sheet

Bi-Color (Multi-Color) Top View LEDs

67-22/R6G6C-B09/2T

Features

- P-LCC-4 package.
- White package.
- Optical indicator.
- Colorless clear window.
- Ideal for backlight and light pipe application.
- Inter reflector.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (8mm Tape).
- Pb-free.
- The product itself will remain within RoHS compliant version

Descriptions

- The 67-22 series is available in soft orange, green, blue and yellow.Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector, this feature makes the ideal for light pipe application.The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

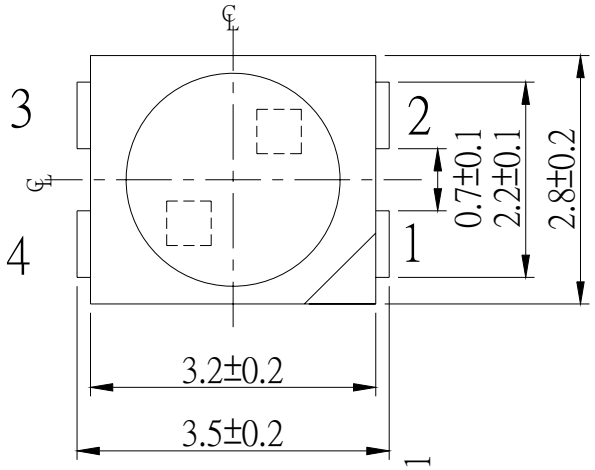
Applications

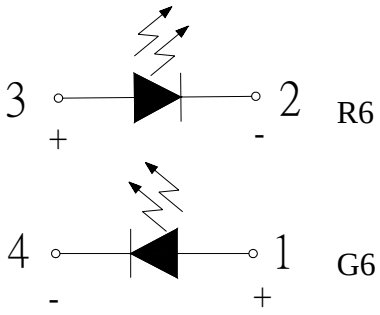
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- General use.

Device Selection Guide

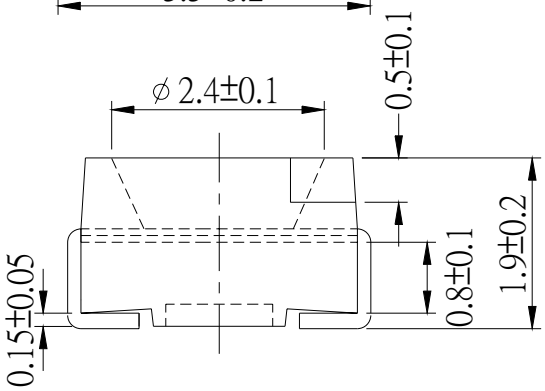
Chip			Lens Color
Type	Material	Emitted Color	
R6	AlGaInP	Brilliant-Red	Water Clear
G6	AlGaInP	Brilliant Yellow Green	

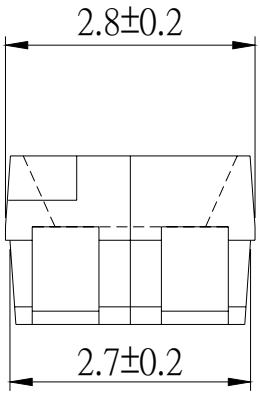
Package Dimensions



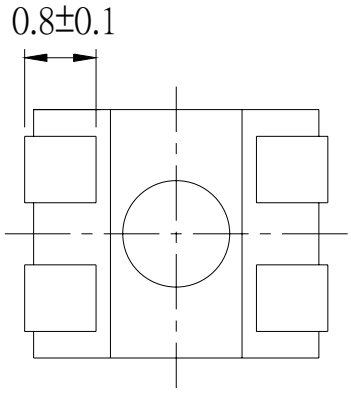


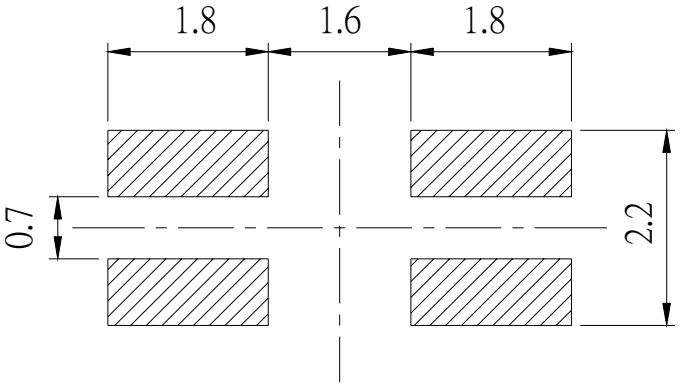
Polarity





For reflow soldering(propose)





Note: The tolerances unless mentioned is ±0.1mm;Unit = mm

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	R6:25 G6:25	mA
Operating Temperature	Topr	-40 ~ +85	℃
Storage Temperature	Tstg	-40~ +100	℃
Electrostatic Discharge(HBM)	ESD	R6:2000 G6:2000	V
Power Dissipation	Pd	R6:60 G6:60	mW
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	R6:60 G6:60	mA
Soldering Temperature	Tsol	Reflow Soldering : 260 ℃ for 10 sec. Hand Soldering : 350 ℃ for 3 sec.	

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_V	R6	57	-----	140	mcd	I_F=20mA
		G6	36	-----	90	mcd	
Viewing Angle	2θ 1/2		-----	130	-----	deg	I_F=20mA
Peak Wavelength	λ p	R6	-----	632	-----	nm	I_F=20mA
		G6	-----	575	-----		
Dominant Wavelength	λ d	R6	621	-----	627	nm	I_F=20mA
		G6	570	-----	574		
Spectrum Radiation Bandwidth	$\triangle\lambda$	R6	-----	20	-----	nm	I_F=20mA
		G6	-----	20	-----		
Forward Voltage	V_F	R6	1.75	-----	2.35	V	I_F=20mA
		G6	1.75	-----	2.35		
Reverse Current	I_R		-----	-----	10	μA	V_R=5V

Notes: **1.Tolerance of Luminous Intensity ±11%**

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

Bin Range of Luminous Intensity

Chip	Bin Code	Min.	Max.	Unit	Condition
R6	P2	57	72	mcd	I_F =20mA
	Q1	72	90		
	Q2	90	112		
	R1	112	140		
G6	N2	36	45		
	P1	45	57		
	P2	57	72		
	Q1	72	90		

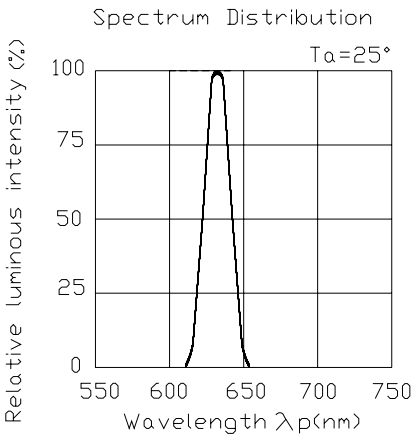
Bin Range of Dominant Wavelength

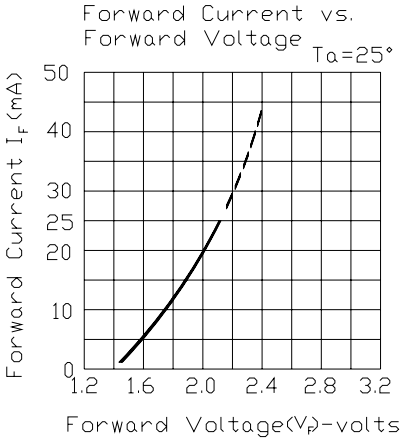
Chip	Bin Code	Min.	Max.	Unit	Condition
R6	0	1.75	1.95	V	I_F =20mA
	1	1.95	2.15		
	2	2.15	2.35		
G6	0	1.75	1.95		
	1	1.95	2.15		
	2	2.15	2.35		

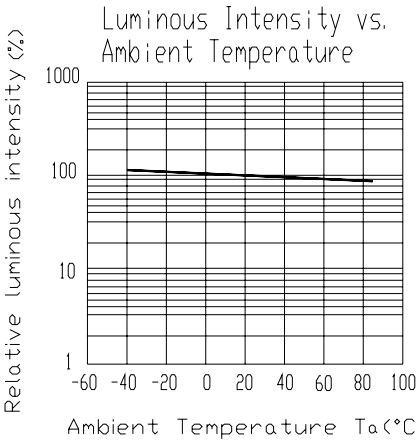
Notes: 1.Tolerance of Luminous Intensity ±11%

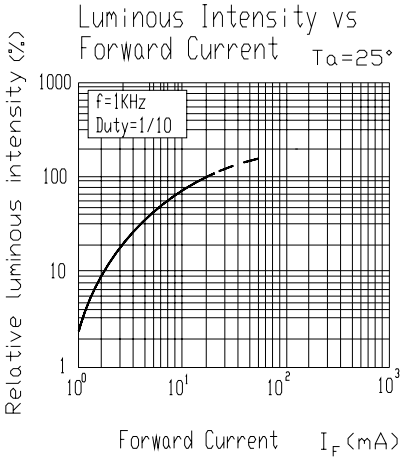
2.Tolerance of Forward Voltage ±0.1V

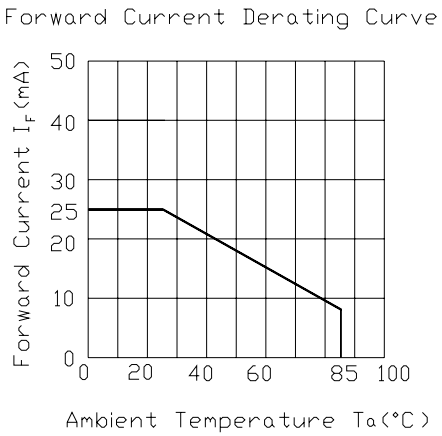
Typical Electro-Optical Characteristics Curves(R6)

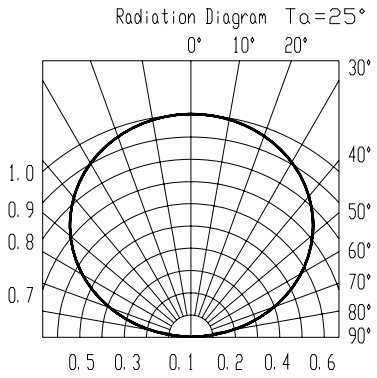




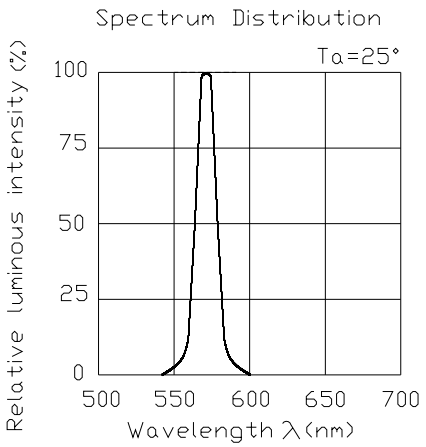


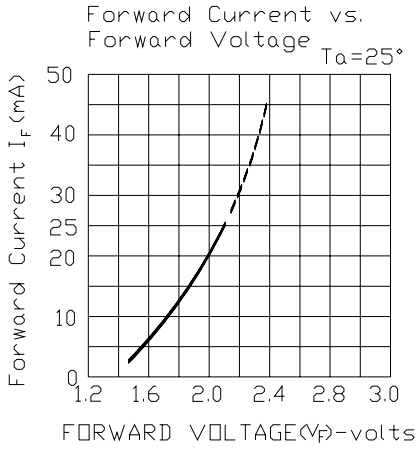


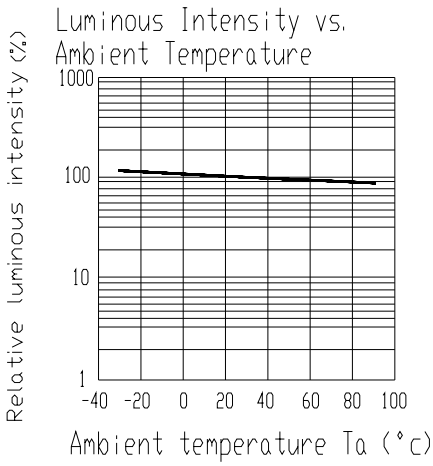


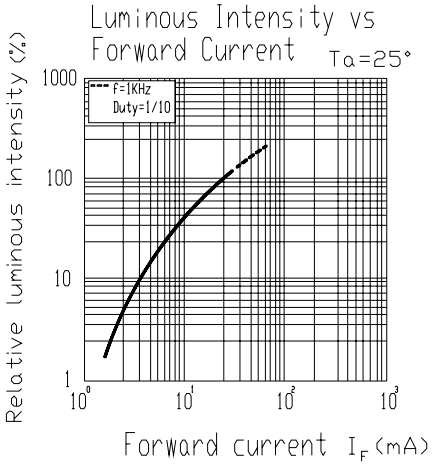


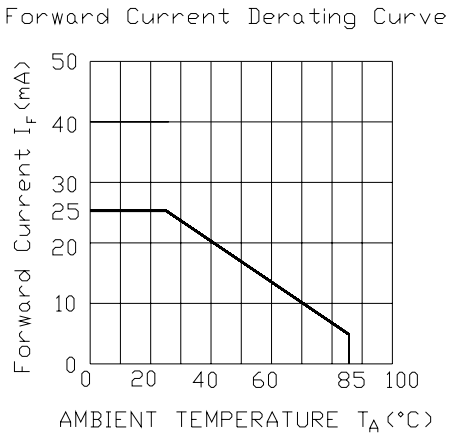
Typical Electro-Optical Characteristics Curves(G6)

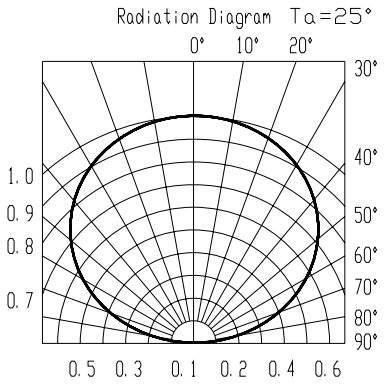










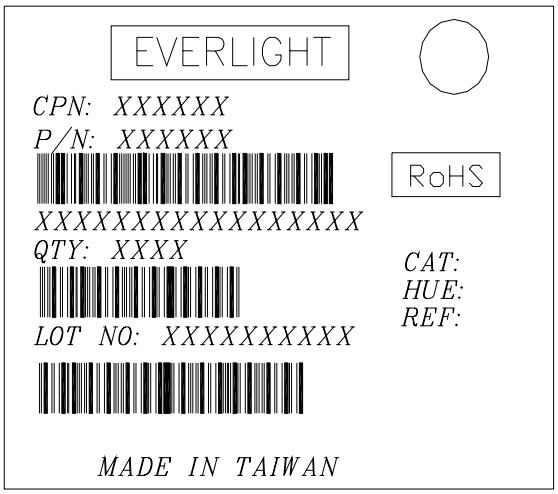


Label explanation

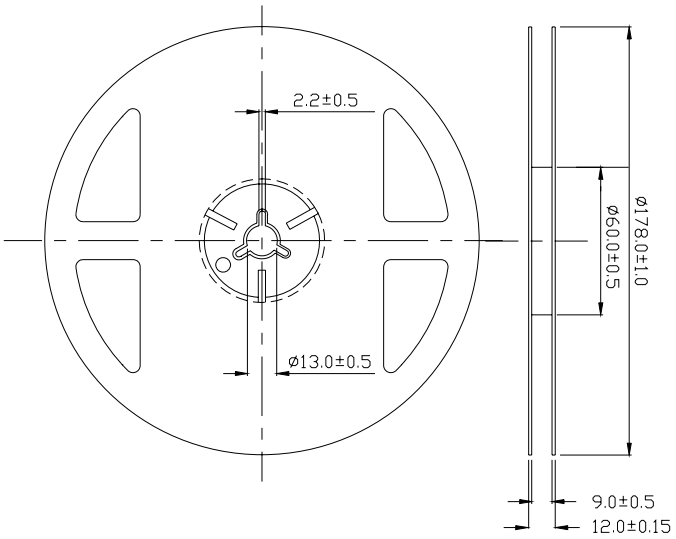
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



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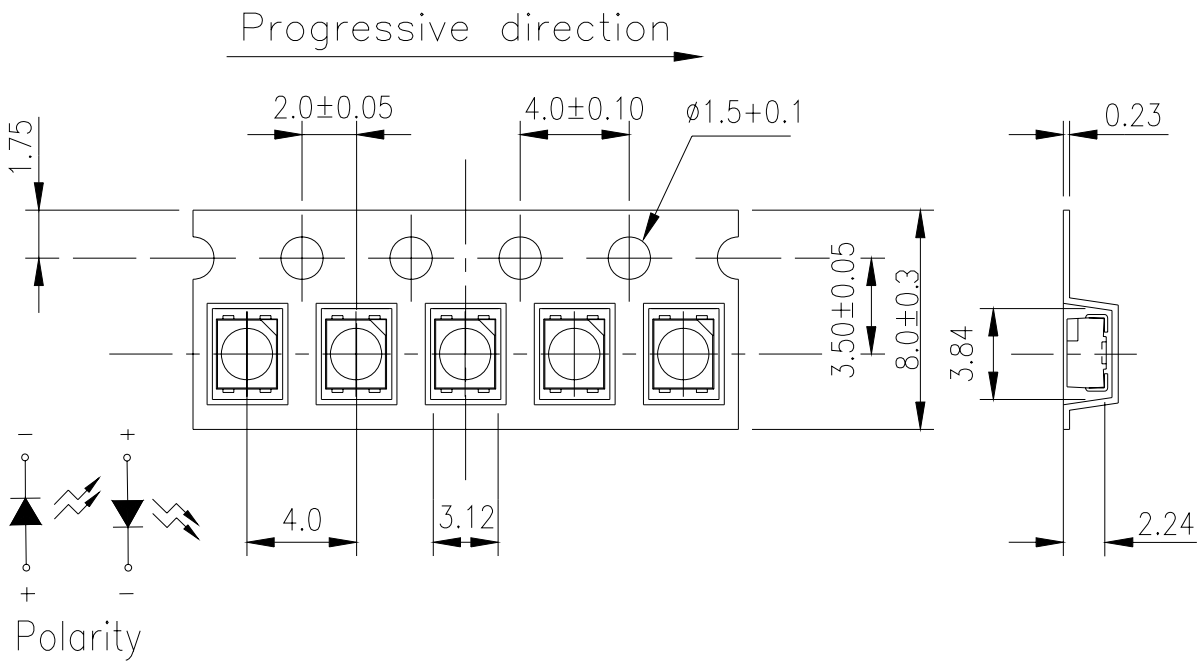
Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



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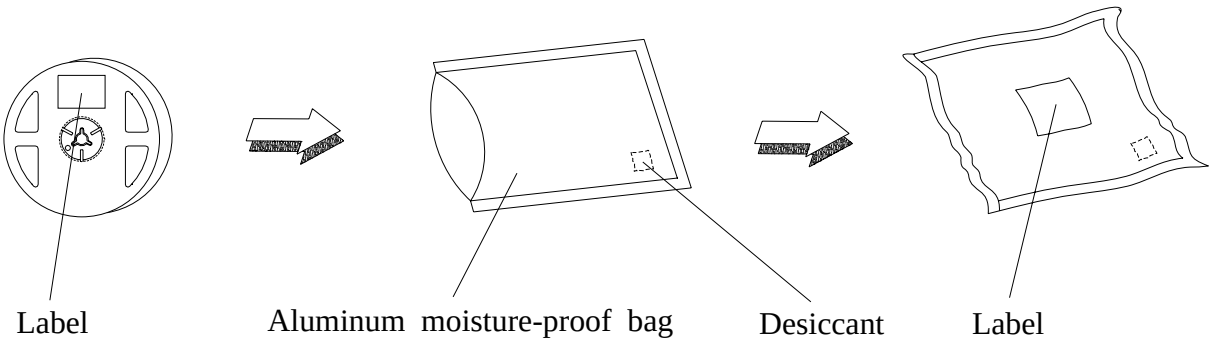
Moisture Resistant Packaging



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level：90%

LTPD：10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260℃±5℃ Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100℃ 15min ∫ 5 min L : -40℃ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100℃ 5min ∫ 10 sec L : -10℃ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I_F = 20 mA/ 25℃	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

   Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

   2.1 Do not open moisture proof bag before the products are ready to use.

   2.2 Before opening the package, the LEDs should be kept at 30℃ or less and 90%RH or less.

   2.3 The LEDs should be used within a year.

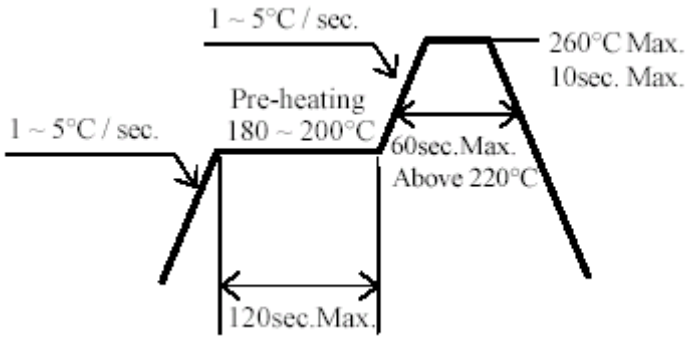
   2.4 After opening the package, the LEDs should be kept at 30℃ or less and 70%RH or less.

   2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

   2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
   Baking treatment : 60±5℃ for 24 hours.

3. Soldering Condition

   3.1 Pb-free solder temperature profile



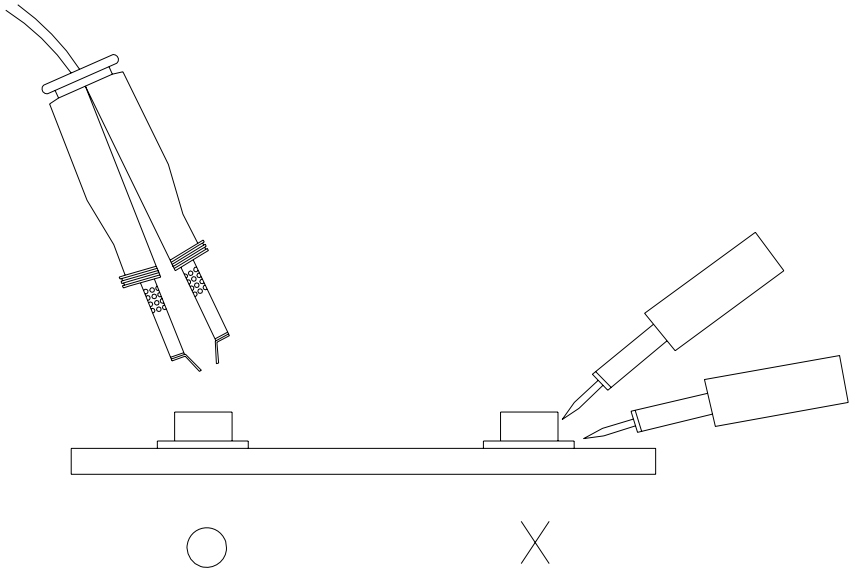
3.2 Reflow soldering should not be done more than two times.
3.3 When soldering, do not put stress on the LEDs during heating.
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350℃ for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.
Office: No 25, Lane 76, Sec 3, Chung Yang Rd,
Tucheng, Taipei 236, Taiwan, R.O.C
Tel: 886-2-2267-2000, 2267-9936
Fax: 886-2267-6244, 2267-6189, 2267-6306
http://www.everlight.com